

Wire Wound Chip Inductors

SWI1008FT Series



INTRODUCTION

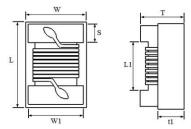
The SWI series are wire wound chip inductors widely used in the communication applications such as cellular phones, cable modem, ADSL, repeaters, Bluetooth, and other electronic devices. The wire wound inductors advance in higher self resonate frequency, better Q factor, and much more stable performance.

FEATURES

- > Operating temperature -40 to +85°C for ferrite series.
- > Excellent solderability and resistance to soldering heat.
- > Suitable for reflow soldering.
- ➤ High reliability and easy surface mount assembly.
- Wide range of inductance values are available for flexible needs.

PART NUMBER

- 1 Product Type
- 2 Chip Dimension



Ī	Size	Length (L)	Width (W)	Thickness (T)	Terminal (S)	L1	W1	t ₁
	(inch) mm	(inch) mm	(inch) mm	(inch) mm	(inch) mm	(Ref.) mm	(Ref.) mm	(Ref.) mm
	SWI 1008 2520	(0.102 ± 0.008) 2.60 ± 0.20	(0.083 ± 0.008) 2.10 ± 0.20	(0.067 ± 0.008) 1.70 ± 0.20	(0.020 ± 0.004) 0.50 ± 0.10	1.40	*1.60~1.9	0.70

- 3 Material Type F: Ferrite
- 4 Inductance Value R47 = 0.47uH 4R7 = 4.7uH 100 = 10uH
- 5 Tolerance $J = \pm 5\%$ $K = \pm 10\%$
- 6 Internal Code

1



1 Scope

This specification applies to fixed inductors of the following types used in electronic equipment:

*Ferrite Type: For higher inductance at lower frequency circuit requirement.

2 Construction

*Configuration

& Dimension: Please refer to the attached figures and tables.

*Terminals : Consist of Ag alloy followed by Nickel, then Sn platting for easier

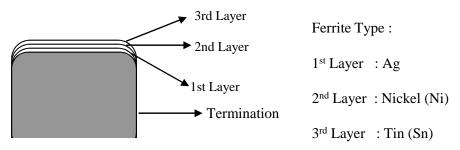
soldering.

3 Operating Temperature Range

Operating Temperature Range is the scope of ambient temperature at which the inductor can be operated continuously at rated current.

*Temp. Range : Ferrite material : -40°C ~ +85°C

4 Ingredient of terminals electrode



5 Characteristics

Standard Atmospheric Conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient Temperature : $25^{\circ}C \pm 2^{\circ}C$

Relative Humidity : 60% to 70%

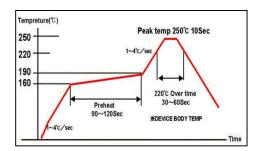
Air Pressure : 86Kpa to 106Kpa



Temperature Profile

1 Reflow Temperature Profile

(Temperature of the mounted parts surface on the printed circuit board)



Recommended Peak Temperature: 250°C Max

250°C up /within 10secs

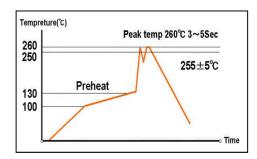
Max. Reflow temperature: 260°C

Gradient of temperature rise : av 1-4°C/sec Preheat : 160-190°C/within 90-120secs

220°C up /within 30-60secs

Composition of solder Sn-3Ag-0.5Cu

2 Dip Temperature



Solder bathtub temperature: 260°C max

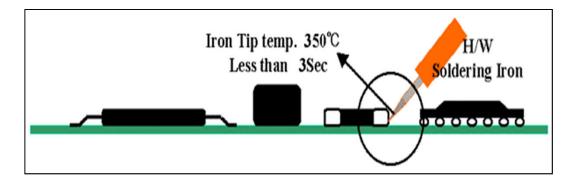
within 5secs.

Preheating temperature: 100~130°C

deposit solder temperature.

Composition of solder Sn-3Ag-0.5Cu

3 Soldering iron tip temperature : 350°C max / within 3 seconds.





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Part No.	Inductance ¹ (uH)	Tolerance	Q ² Min	S.R.F. ³ Min (MHz)	RDC ⁴ Max (Ω)	IDC ⁵ Max (mA)	Marking
SWI1008FT R47 □-□□	0.47 @ 25MHz	K, J	45 @ 100MHz	480	0.55	500	R47
SWI1008FT R56 □-□□	0.56 @ 25MHz	K, J	45 @ 100MHz	430	0.60	500	R56
SWI1008FT R68 □-□□	0.68 @ 25MHz	K, J	45 @ 100MHz	380	0.80	500	R68
SWI1008FT R82 □-□□	0.82 @ 25MHz	K, J	45 @ 100MHz	350	0.92	500	R82
SWI1008FT 1R0 □-□□	1.0 @ 25MHz	K, J	35 @ 50MHz	310	1.75	430	1R0
SWI1008FT 1R2 □-□□	1.2 @ 7.96MHz	K, J	20 @ 7.96MHz	280	1.30	230	1R2
SWI1008FT 1R5 □-□□	1.5 @ 7.96MHz	K, J	20 @ 7.96MHz	250	1.65	220	1R5
SWI1008FT 1R8 □-□□	1.8 @ 7.96MHz	K, J	20 @ 7.96MHz	200	2.20	210	1R8
SWI1008FT 2R2 □-□□	2.2 @ 7.96MHz	K, J	20 @ 7.96MHz	160	2.35	200	2R2
SWI1008FT 2R7 □-□□	2.7 @ 7.96MHz	K, J	20 @ 7.96MHz	130	2.60	195	2R7
SWI1008FT 3R3 □-□□	3.3 @ 7.96MHz	K, J	20 @ 7.96MHz	80	2.85	185	3R3
SWI1008FT 3R9 □-□□	3.9 @ 7.96MHz	K, J	20 @ 7.96MHz	50	4.00	180	3R9
SWI1008FT 4R7 □-□□	4.7 @ 7.96MHz	K, J	20 @ 7.96MHz	45	4.30	175	4R7
SWI1008FT 5R6 □-□□	5.6 @ 7.96MHz	K, J	20 @ 7.96MHz	42	2.60	170	5R6
SWI1008FT 6R8 □-□□	6.8 @ 7.96MHz	K, J	20 @ 7.96MHz	39	2.80	165	6R8
SWI1008FT 8R2 □-□□	8.2 @ 7.96MHz	K, J	20 @ 7.96MHz	36	3.05	160	8R2
SWI1008FT 100 □-□□	10 @ 2.52MHz	K, J	15 @ 2.52MHz	33	3.50	150	100
SWI1008FT 120 □-□□	12 @ 2.52MHz	K, J	15 @ 2.52MHz	30	3.60	140	120
SWI1008FT 150 □-□□	15 @ 2.52MHz	K, J	15 @ 2.52MHz	26	4.00	130	150
SWI1008FT 180 □-□□	18 @ 2.52MHz	K, J	15 @ 2.52MHz	24	4.50	120	180
SWI1008FT 220	22 @ 2.52MHz	K, J	15 @ 2.52MHz	22	5.00	110	220
SWI1008FT 270	27 @ 2.52MHz	K, J	15 @ 2.52MHz	21	6.00	95	270
SWI1008FT 330 □-□□	33 @ 2.52MHz	K, J	15 @ 2.52MHz	20	6.50	85	330
SWI1008FT 390 □-□□	39 @ 2.52MHz	K, J	15 @ 2.52MHz	18	8.50	60	390
SWI1008FT 470	47 @ 2.52MHz	K, J	15 @ 2.52MHz	17	14.00	45	470

^{1.} Inductance is measured in HP-4287A RF LCR meter with HP-16193 fixture.

5. For 15 °C Rise.

Remarks:

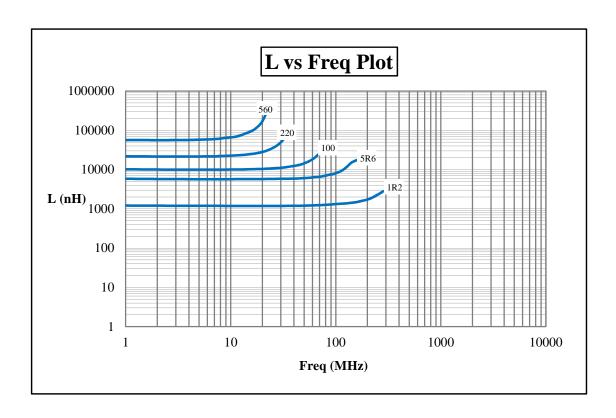
Unit weight = 0.025g (for ref.)

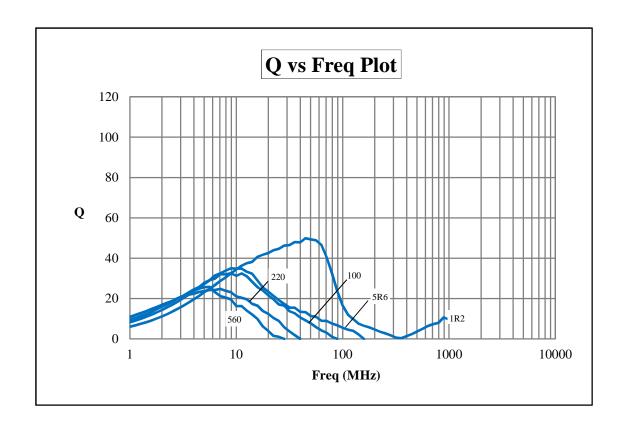
^{2.} Q is measured in HP-4287A RF LCR meter with HP-16193 fixture.

^{3.} SRF is measured in ENA E5071B network analyzer or equivalent.

^{4.} RDC is measured in HP-4338B milliohmeter or equivalent.







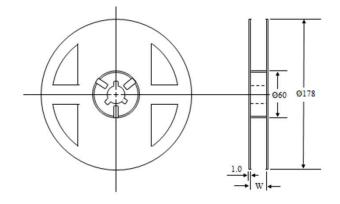


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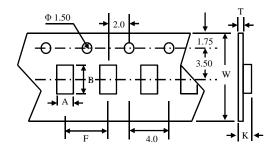
ITEM		CONDITION	SPECIFICATION	
	Inductance and	Measuring Frequency:	Within Specified Tolerance	
	Tolerance	As shown in Product Table	-	
	Quality Factor	Measuring Temperature : +25°C		
	Insulation	Measured at 100V DC between	1000 mega ohms minimum	
Electrical	Resistance	inductor terminals and center of case.		
Characteristics	Dielectric	Measured at 500V AC between	No damage occurs when	
	Withstanding	inductor terminals and center of case	the test voltage is applied.	
	Voltage	for a maximum of 1 minute.		
	Temperature	Over -40°C to +85°C at	+25 to 500 ppm/°C	
	Coefficient of	frequency specified in Product Table.	$TCL = L1 - L2 x 10^6 (ppm / ^{\circ}C)$	
	Inductance (TCL)		L1(T1-T2)	
	Component	The component shall be reflow soldered onto a	0402 series - 350g	
	Adhesion	P.C. Board ($240^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 20 seconds).	0603 series - 1.0Kg	
	(Push Test)	Then a dynometer force gauge shall be applied	Other series - 0805 ~ 1210	
		to any side of the component.	Minimum 1Kg for Ag termination	
Mechanical			and 2Kg for Mo/Mn termination.	
Characteristics	Drop Test	The inductor shall be dropped two times on the	Change In Inductance:	
011111 1101		concrete floor or the vinyl tile from 1M naturally.	No more than 5%	
	Thermal Shock	Each cycle shall consist of 30 minutes at -40°C	Change In Q:	
	Test	followed by 30 minutes at +85°C with a 5 minutes	No more than 10%	
		transition time between temperature extremes.	Change In Appearance:	
		Test duration is 10 cycles.	Without distinct damage	
	Solderability	Dip pads in flux and dip in solder pot containing	A minimum of 80% of the metalized	
		lead free solder at 240°C ± 5°C for 5 seconds.	area must be covered with solder.	
	Resistance to	Dip the components into flux and dip	Change In Inductance:	
	Soldering Heat	into solder pot containing lead free solder	No more than 5%	
	779	at $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 5 ± 2 seconds.	Change In Q:	
	Vibration	Inductors shall be randomly vibrated at amplitude	No more than 10%	
	(Random)	of 1.5mm and frequency of 10-55Hz: 0.04G/Hz	Change In Appearance:	
		for a minimum of 15 minutes per axis for each of	Without distinct damage	
	Cald Tamas natura	the three axes.		
	Cold Temperature	Inductors shall be stored at temperature of $-40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for 1000hrs (+48 -0 hrs.)		
	Storage			
		Then inductors shall be subjected to standard atmospheric conditions for 1 hour.		
Endurance		After that, measurement shall be made.		
Characteristics	High Temperature	Inductors shall be stored at temperature		
	Storage	of 85° C $\pm 2^{\circ}$ C for 1000hrs (+48 -0 hrs.)		
	Storage	Then inductors shall be subjected to standard		
		atmospheric conditions for 1 hour.		
		After that, measurement shall be made.		
	Moisture	Inductors shall be stored in the chamber at 45°C	Inductors shall not have a	
	Resistance	at 90-95 R.H. for 1000 hours. Then inductors are	shorted or open winding.	
		to be tested after 2 hours at room temperature.	1	
	High Temperature	Inductors shall be stored in the chamber at +85°C		
	with Loaded	for 1000 hours with rated current applied.		
		Inductors shall be tested at the beginning of test at		
		500 hours and 1000 hours. Then inductors are to		
		be tested after 1 hour at room temperature.		
		22 122 date 1 1 110 da de 100 in temperature.		

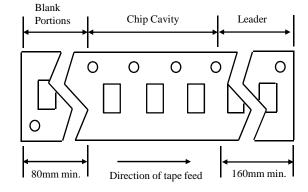


Туре	Pcs/Reel	
SWI1008	2,000	



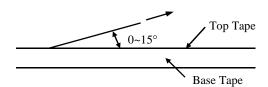
Туре	Chip Cavity		Insert Pitch	Tape Thickness		iess
	A	В	F	K	T	W
SWI1008	2.20	2.83	4.00	1.75	0.22	8.00





Top Tape Strength

The top tape requires a peel-off force of 0.2 to 0.7N in the direction of the arrow as illustrated below.



Dimensions (unit: m/m)

Туре	A	В	C	
SWI1008	3.00	1.20	2.20	

Recommended Pattern

